<u>SPECIFICATION</u>	<u>۲</u>	<u>SPEC. No.</u> DATE:		
То				
			For Automoti	ive
CUSTOMER'S PRODUCT NAME		ulated capacitors	disc type safety si \OOO⊟A◇K	
RECEIPT CONFIRMATION				
	DATE:	YEAR	MONTH	DA
TDK Corporation Sales	Engineering			
	Engineering Ceramic Capacito	ors Business Gro	up.	
Sales Electronic Components Sales &		ors Business Gro CHECKED	up . Person in ch	arg

Handling precautions for High voltage ceramic capacitors Please read the following closely before using these products. Safety precautions The following precautions should be observed strictly to ensure safety design. Misuse of the product may lead to smoking of the product. Cautions 1.Operating voltage Use within the rated voltage of capacitor between terminals. For DC rated voltage application, you should control the peak voltage (Vo-p) under the rated voltage in case the AC voltage is superimposed on the DC voltage. Use within the rated voltage includes peak voltage (Vp-p) when AC voltage or impulse voltage applied in a circuit. Confirm irregular voltage (surge voltage, static electricity, switching noise, etc) occurs in the equipment used, and use within the rated voltage containing the irregular voltage. When the capacitor is used as a noise suppressor in the AC primary circuit, the voltage proof test should be within the specified conditions (voltage, time, wave form, etc). Connect by confirmation of non lose contact, and the voltage is started to apply to the circuit from zero to the specified voltage and it is stopped applying from the voltage to zero. Voltage (1) DC voltage (2) DC+AC voltage (3) AC voltage (4) Pulse voltage Voltage V_{P-P} V_{0-P} V_{0-P} Measuring position 0-2. Operating temperature Be sure to use only those operating temperature described in our catalogue or specification. Keep the surface temperature under the maximum temperature, which includes the maximum self-heat temperature of 20 degree C. 3. Self-exothermal Self-exothermal temperature should be within 20 degree C on the condition of atmosphere temperature 25 degree C without the influence of wind such as the cooling fan. Be sure to use a capacitor in a circuit of current increase by AC voltage or pulse voltage applied. When high frequency voltage or impulse voltage applied in a circuit, reliability should be influenced. Take into considerations the load reduction and self-exothermal temperature, even if voltage should be within the rated voltage. PLP Spec No. HV095F19



	Cautions	
 Capacitance change of capacitors For some of the capacitors, capacitance value by applied DC voltage. And capacitor has agin When you use the capacitor in the time consta not. 	g characteristic (capacitance d	ecreases by keeping as it is
 Vibration of capacitors When the capacitor class 2 is used in the AC c might occur in the specified frequency. Be sur 		-
 6. Usage of capacitance and storage Don't use capacitors in the following environme * Direct sunshine * Areas directly exposed to water or salty w * Areas that become dewy * Areas filled with toxic gases (such as hydres as a strate of the excess vibrations or shore store capacitors in an environment from -10 to and use within the period after receiving the capacitor 	rogen sulfide, sulfur dioxide, ch ock conditions described in our 9 40 degree C, with 15 to 70%F	catalogue or specification.
7. Inserting precautions When inserting capacitors into the PC board by (such as pressure of pusher, adjustment of clin chucking the body, or clinching the lead termin Distances between the hole position onto a PC When stretching the lead terminal, any force m damage to the insulation coating. Severe damage	iching portion) and minimize th als. C board should be equal to the nay load the bottom of the capa	e impact force by pitch of capacitors. acitor body and result in
 8. Soldering Don't immerse the capacitor body into the mol soldering. Use PC board, and solder the termi such as pre-heat temperature, soldering temp descriptions in our catalogue or specification. Adjust the amount of solder within the proper v When using soldering iron for installing capaci and temperature control should be used. We a 3.5±0.5s. as 1 time, and you should use an ad well as a proper wattage (50W Max.). Do except for the terminals of capacitor.	ten solder, and don't solder the nals in the opposite side of the erature, and soldering time, sh (refer to Fig1) volume. Select an appropriate tors or reworking onto the PC recommend that the iron cond dequate tip diameter (φ3mm M	e terminals by reflow body. Soldering conditions nould be followed by the soldering material. board, sufficient pre-heating ition is 350±10 degree C/ fax.) with the soldering iron
 Flux When using flux for soldering capacitors onto the Flux will be composed of halogenated materiation be done. 	al less than 0.1 wt% (cl conv	version).
	PLP Spec No.	HV095F19



✓ Cautions 10. Cleansing When the cleansing should not be sufficient, the cleansing liquid or any residue might leave on the capacitor body, they may deteriorate the insulation coating or performance (insulation resistance, etc.). When using ultrasonic cleansing, avoid transmitting vibrations onto the PC board. Conditions of ultrasonic cleansing, such as output frequency and time of the method, should be taken into considerations. After cleansing capacitors, dry them well. Cleansing liquid should not contain electrolyte, nor leave any residue. Through the result of the cleansing method, confirm whether the quality of the capacitors have been affected due to the conditions. 11. Coating or molding When coating or molding capacitors after installing components onto the PC board, confirm whether the performance of capacitors may not be damaged by the work. 12. Mechanical stress Don't submit to excessive mechanical shock. Don't use capacitors which may have been damaged due to dropping, etc. If possible, avoid bending the terminals of capacitors. In an unavoidable case of bending, use a small jig to decrease the mechanical stress on the capacitors. 13. Others Please contact TDK before using our capacitors listed in this catalogue or specifications for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property, or when intending to use one of our capacitors for other applications than specified in this catalog or specifications. * Medical equipment * Aerospace equipment * Power plant equipment * Aircraft equipment * Transportation equipment (vehicles, trains, ships, etc) * Undersea equipment * Traffic signal equipment * Disaster prevention, crime prevention equipment * Data processing equipment exerting influence on public * Application of similar complexity and, or reliability requirements to the applications listed in the above. Please refer to the guideline of notabilia for fixed ceramic capacitors issued by JEITA (Japan Electronics and Information Technology Association, EIAJ RCR-2335). PLP Spec No. HV095F19



	amic insulated capacitors disc type us stronic and equipment and approved tandards.	-
Relative standards IEC 60384-14、EN60384-14、U	L60384-14	
Mention item 1. Applicable safety standard app 2. Acquired safety standard app 3. Part Name 4. Operating temperature range 5. Test condition 6. Performance 7. Marking 8. Figure & Dimension 9. Label & Transport 10. Notification before the modified	roval and Approval report No.	
We do not use the following materi (1) PBBOs (Poly Bromo Bipheny (2) PBBs (Poly Bromo Bipheny	yl Oxides)	
We do not use Class I and II ODS	(Ozone depleting substances) in all our proc	cess of these products.
These products shall conform to Ro	oHS Directive.	
These products are Halogen-free.(Br≦900ppm, Cl≦900ppm, Br+Cl≦150	00ppm)
Manufacturing place Manufacturing site should be TD	K Taiwan & TDK Xiamen	
Division	Date Issued	SPEC. No.
Ceramic Capacitors Business Group		
L	1	



1. Applicable safety standard

This is specification applies the BSI, VDE, SEV, SEMKO, FIMKO, NEMKO, DEMKO, SAA, IMQ, UL, CSA and CQC,KTL approved ceramic capacitor disc type.

Safety	Standard No. of IEC	Standard No. T.C. Subclass W.V		Approval	report No.			
Standard	Standard No. OF IEC	Standard No.	1.0.	SUDCIASS	VV. V	Taiwan	Xiamen	
BSI	BS EN 60384-14 IEC 60384-14	BS EN 60065 (8.8、14.2) BS EN 60384-14				KM37103		
VDE						4001	7930	
SEV						15.0	120	
SEMKO						1406	6932	
NEMKO		EN 60384-14				P122	215336	
DEMKO			SL,	X1,	X1:440VAC Y2:300VAC	D-01153		
FIMKO				Y2		FI 27399		
IMQ			В,		V3692			
SAA	IEC 60384-14	AS3250	Z5U,			CS6268		
CSA		CSA-E60384-14				1785515		
UL		UL60384-14				E37861		
CQC		GB/T14472				CQC1200 1082619	CQC1000 1052862	
]			X1	440V AC	SZ03001	SU03047	
кті		K60384-14			440V AC	-12006	-12006	
KTL				Y2	300V AC	SZ03001	SU03047	
				12		-12008	-12008	

2. Acquired safety standard approval and Approval report No..

* T.C.: Temperature Characteristic.

* Certificate No(s) shall be changed owing to the revisions of the related standards and renewal of certificate.



3. Part name

	(Evennele)	
(Example)	

(Example)		
<u>CS 80 ZU 2GA 222 M A G</u>	<u>K A</u>	
		Halogen-free
		Safety (Miniature Type)
		Lead style
		Automotive use
		Rated capacitance tolerance
		Rated capacitance
		Rated voltage
		Temperature characteristic of capacitance %Note-1
		Internal control No.
		Туре

X Note-1

Temperature characteristic of capacitance : SL:TC SL, -B:TC B, ZU:TC Z5U

※ Note-2

Lead style G: Vertical kink long lead (Bulk)

- N : Vertical kink short lead (Bulk)
- V : Vertical kink long lead (Taping)
- 4. Operating Temperature range : -25 °C to +125 °C

Operating temperature range max. is +125 °C

(Including capacitor's self-heating max. +20 °C)

5. Test condition

Test and measurement shall be made at the standard condition, (Temperature 15 to 35 $^{\circ}$ C, relative humidity 45 to 75 % and atmospheric pressure 860 to 1060 Pa.),Unless otherwise specification herein. If doubt occurred on the value of measurement, and remeasurement was requested by customer capacitors shall be measured at the reference condition (Temperature 20 ±2 $^{\circ}$ C, relative humidity 60 to 70 % and atmospheric pressure 860 to 1060 Pa.)

6. Performance

The performances shall comply with Table-1



-3 -

	[Table-T				
No.	Items		Performance	Test method			
1	Appearance and dimension		The appearance and dimension shall be as given in paragraph 8 and Table-2 to 5	Visual check and measuring with micrometer.			
2	Marking Withstand Between		The marking shall be easily legible (Paragraph 7)	Visual check			
3	Withstand voltageBetween terminalsBetween terminal and exterior claddingInsulation resistanceInsulation resistanceDissipation factor (tanδ)Capacitance temperature characteristic 		voltage terminals		No failure	Voltage: 2600V AC (50 or 60 Hz) Test time: 60 s Charge and discharge current shall be 50 mA or less.	
			No failure	2600VAC (50 or 60Hz) shall be applied for 60 s between the terminal connected together and the enclosure of capacitor with metal foil from the distance 4mm of th body.			
4	resistance terminals		10000 MΩ or more	60±5 sec. after application with 500±50V DC.			
5	Capacitance Dissipation factor		With the tolerances specified with Table-3 to 5	SL: Measuring frequency : 1MHz ±10 %			
6			•			 Measuring voltage : 5Vrms. or less B,Z5U Measuring frequency : 1kHz ±20 % Measuring voltage : 5Vrms. or less 	
7	characteristic		SL :Within -1000 to +350ppm/°C B :Within ± 10% Z5U:Within - 56% to + 22%				
8	Strength of terminal	Tensile strength	Lead wire shall not be discon- nected, and capacitor shall not be damaged.	The force of 10N shall be applied to the axial direction of the termination.			
		Bending strength	Lead wire shall not be discon- nected, and capacitor shall not be damaged.	The force of 5N shall be applied to the axial direction of the terminal and the body shall be inclined through an angle of 90 degrees, then the body shall be returned to the original position. Furthermore the body shall be inclined to the other direction of 90 degrees. This operation shall be carried out two times.			
9	Vibration resistance			Displacement: 1.5mm Acceleration: 5G Vibration frequency range:10 to 2000 to			



			Table-1 Continue	
No.	Item	าร	Performance	Test method
10	Resistance to	Appearance	No marked defect	Soldering temperature:350±10°C/3.5±0.5 s
	soldering heat	Capacitance	Within : ±10 %	or 260±5°C/10±1 s
		change		Dipping depth: 1.5 to 2.0mm from the
		Withstand	No failure	bottom of lead terminal.
		voltage		(shielding board shall be used.)
		Between		Initial :pre-heat 125±2°C, 1h. Leaving room temp. for24±2h.
		└ terminals J		After test: leaving room temp. for $24\pm2h$.
11	Solderability		At least 3/4 of circumferential	Soldering temperature : 245 ±5 °C
			dipped into solder shall be	Dipping time : 2 ± 0.5 sec.
			covered with new solder.	Concentration of solution shall be about
				25 % colophonium in weight ratio
12	Heat shock test		No marked defect	Test condition:
		Capacitance	SL、B : Within ±10 %	(-55°C/30min.←→+125°C/30min.)
		change	Z5U : Within ±20 %	*1000 cycles.
		Dissipation	SL : 1.0 % or less	Initial :pre-heat 125±2°C,1h,
		factor	B, Z5U: 5.0 % or less	Leaving room temp. for 24 ± 2 h.
		(tan δ)	0000 140	After test: leaving room temp. for 24±2 h.
		Insulation	3000 MΩ or more	
		resistance Withstand	No failure	
		voltage	no fallure	
		Between		
		terminals		
13	Moisture	Appearance	No marked defect	Test temperature : 85±2°C
	resistance	Capacitance	Within ±15 %	Relative humidity: 80 to 85 %
	(Steady state)	change		Test time :1000+12, -0 hours.
		Insulation	3000 MΩ or more	Capacitors shall be measured after leaving it
		resistance		under room temperature for 1 to 2 hours.
		Withstand	No failure	
		voltage		
14	Moisture	Appearance	No marked defect	Test temperature : 85±2 °C
	resistance	Capacitance	Within ±15 %	Relative humidity:80 to 85%
	loading	change	2000 MO or more	Test time:1000+12, -0 hours 440VAC applied.
		Insulation resistance	3000 MΩ or more	Capacitors shall be measured after leaving it under room temperature for 1 to 2 hours.
		Withstand	No failure	Charging and discharging current shall be
		voltage		50mA or less.
15	High tempera-	Appearance	No marked defect	Test temperature : 125±3 °C
	ture loading	Capacitance	Within ±20 %	Test time: 1000+24,-0 hr. 550VAC applied.
		change		(The voltage is increased to 1000Vrms for
		Insulation	3000 MΩ or more	0.1sec once every hour)
		resistance		Initial :pre-heat 125±2°C, 1h.
		Withstand	No failure	Leaving room temp. for24±2h.
		Voltage		After test: leaving room temp. for 24±2h
				Charge and discharge current shall be 50mA
				or less.
16	Impact test	Appearance	No marked defect	Waveform : Half-sine
		Capacitance	Within ±20 %	Acceleration : 100G
		change	2222 142	Time:6msec
		Insulation	3000 MΩ or more	X, Y, Z, and reverse direction.
		resistance	No failure	3 times each
		Withstand Voltage		Capacitor is fixed by resin.
1		voilage		



7. Marking

Marking on one side.

- (1) Type : CS
- (2) Rated capacitance tolerance

Example 2200 pF : 222

±20 % : M

(3) Subclass

Sub class	Rated voltage	Marking
X1	440 V AC	440~X1
Y2	300 V AC	300~Y2

(4) Manufacture's trade mark



(6) Automotive use

The horizontal line under Date Code



8. Figure & dimension

8.1 Vertical kink long lead (Lead style: G /Bulk)







%1 Coating on lead shall not extend beyond the bottom of vertical kink.

Unit: mm



%2 Coating thickness is 0.4mm Min. from the live part.





8.3 Vertical kink long lead (lead style: V / Taping)

(F=7.5mm, Pitch: 15.0mm)



		Table-2	Unit: mm
Item	Symbol	Dimension	Remarks
Name Body diameter	D	Table-5	
Body thickness	T	Table-5	
Lead-wire diameter	φd	0.6 ±0.05	
Pitch of component	P	15.0 ±1.0	Including the slant of body
Feed hole pitch	P ₀	15.0 ±0.3	Excepting the tape splicing part
Feed hole center to lead	P ₁	3.75 ±0.7	
Feed hole center to component	P ₂	7.5±1.3	Including the slanting body due to bending lead-wire
Lead-to lead distanc	F	7.5±0.8	Measuring point is bottom kink
Component alignment, F-R	∆h	0 ± 2.0	Including the slanting body due to bending lead-wire
Tape width	W	18+1.0,-0.5	
Adhesive tape width	W _o	10.0 Min.	
Hole position	W ₁	9.0 ±0.5	
Adhesive tape position	W_2	4.0 Max.	Adhesive tape do not stick out the tape
Bottom of kink from tape center	H _o	16 +1.5,-0.5	
Height of body from tape center	Η ₁	46.0 Max.	
Lead-wire protrusion	ł	1.0 Max.	
Feed hole diameter	D ₀	4.0 ±0.2	
Total tape thickness	t	0.6 ±0.3	Including adhesive tape
Length of snipped lead	L	11.0 Max.	
Coating on lead	С	4.0 Max.	
Height of kink	A	4.0 Max.	Measuring point is bottom of kink
Spring action	S	2.0 Max.	



- Note-1 Use the gummed tape to connect two ends of broken tape.
- Note-2 Dropouts of parts shall be limited to no more than three consecutive parts.
- Note-3 Packaging method and dimensions see below.
- Note-4 Quantity Pitch: 15.0mm 1000 pcs. /Box.

Packaging : Ammo pack





Unit:mm

Note-5 Package of shipment Capacitors pack in downward



9. Labe1 and transport

Capacitors shall be packaged prior to shipment so as to prevent damage during transportation and storage. Shipping carton contains the following information on the label.

- a) TDK item name
- b) Quantity
- c) TDK inspection number
- d) Manufacturer's name
- e) Country of origin

Bulk



10. Notification before the modification

We'll previously notify the modified place of manufacture, manufactured articles and materials.



Vertical kink long lead (lead style: G / bulk)

			Table-3						
Your part No	TDK part No.	T.C.	Cap.	C-Tol.	Dime	Dimension		(Unit : mm)	
	TDR part No.	1.0.	(pF) (%	(%)	D Max.	Т Мах.	F	φd	
	CS45SL2GA100JAGKA	SL	10	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA150JAGKA	SL	15	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA220JAGKA	SL	22	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA330JAGKA	SL	33	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA470JAGKA	SL	47	± 5	8.0	7.0	7.5±1.5	0.6	
	CS45SL2GA680JAGKA	SL	68	± 5	9.0	7.0	7.5±1.5	0.6	
	CS65-B2GA101KAGKA	В	100	± 10	7.0	7.0	7.5±1.5	0.6	
	CS65-B2GA151KAGKA	В	150	± 10	7.0	7.0	7.5±1.5	0.6	
	CS65-B2GA221KAGKA	В	220	± 10	7.0	7.0	7.5±1.5	0.6	
	CS70-B2GA331KAGKA	В	330	± 10	7.5	7.0	7.5±1.5	0.6	
	CS75-B2GA471KAGKA	В	470	± 10	9.0	7.0	7.5±1.5	0.6	
	CS85-B2GA681KAGKA	В	680	± 20	9.5	7.0	7.5±1.5	0.6	
	CS65ZU2GA102MAGKA	Z5U	1000	± 20	7.0	7.0	7.5±1.5	0.6	
	CS75ZU2GA152MAGKA	Z5U	1500	± 20	8.0	7.0	7.5±1.5	0.6	
	CS80ZU2GA222MAGKA	Z5U	2200	± 20	9.5	7.0	7.5±1.5	0.6	
	CS95ZU2GA332MAGKA	Z5U	3300	± 20	12.0	7.0	7.5±1.5	0.6	
	CS11ZU2GA472MAGKA	Z5U	4700	± 20	13.5	7.0	7.5±1.5	0.6	



Vertical kink short lead (lead style: N / bulk)

			Table-4						
Your part No	TDK part No.	T.C.	Cap.	C-Tol.	Dime	Dimension		(Unit : mm)	
Tour part No	TDR part No.	1.0.	(pF)	(%)	D Max.	T Max.	F	φd	
	CS45SL2GA100JANKA	SL	10	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA150JANKA	SL	15	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA220JANKA	SL	22	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA330JANKA	SL	33	± 5	7.0	7.0	7.5±1.5	0.6	
	CS45SL2GA470JANKA	SL	47	± 5	8.0	7.0	7.5±1.5	0.6	
	CS45SL2GA680JANKA	SL	68	± 5	9.0	7.0	7.5±1.5	0.6	
	CS65-B2GA101KANKA	В	100	± 10	7.0	7.0	7.5±1.5	0.6	
	CS65-B2GA151KANKA	В	150	± 10	7.0	7.0	7.5±1.5	0.6	
	CS65-B2GA221KANKA	В	220	± 10	7.0	7.0	7.5±1.5	0.6	
	CS70-B2GA331KANKA	В	330	± 10	7.5	7.0	7.5±1.5	0.6	
	CS75-B2GA471KANKA	В	470	± 10	9.0	7.0	7.5±1.5	0.6	
	CS85-B2GA681KANKA	В	680	± 20	9.5	7.0	7.5±1.5	0.6	
	CS65ZU2GA102MANKA	Z5U	1000	± 20	7.0	7.0	7.5±1.5	0.6	
	CS75ZU2GA152MANKA	Z5U	1500	± 20	8.0	7.0	7.5±1.5	0.6	
	CS80ZU2GA222MANKA	Z5U	2200	± 20	9.5	7.0	7.5±1.5	0.6	
	CS95ZU2GA332MANKA	Z5U	3300	± 20	12.0	7.0	7.5±1.5	0.6	
	CS11ZU2GA472MANKA	Z5U	4700	± 20	13.5	7.0	7.5±1.5	0.6	

公TDK



Vertical kink long lead (lead style: V / Taping)

			Table-5		-			
Your part No	TDK part No.	T.C.	Cap. (pF)	C-Tol. (%)	Dimension		(Unit : mm)	
					D Max.	T Max.	F	φd
	CS45SL2GA100JAVKA	SL	10	± 5	7.0	7.0	7.5±0.8	0.6
	CS45SL2GA150JAVKA	SL	15	± 5	7.0	7.0	7.5±0.8	0.6
	CS45SL2GA220JAVKA	SL	22	± 5	7.0	7.0	7.5±0.8	0.6
	CS45SL2GA330JAVKA	SL	33	± 5	7.0	7.0	7.5±0.8	0.6
	CS45SL2GA470JAVKA	SL	47	± 5	8.0	7.0	7.5±0.8	0.6
	CS45SL2GA680JAVKA	SL	68	± 5	9.0	7.0	7.5±0.8	0.6
	CS65-B2GA101KAVKA	В	100	± 10	7.0	7.0	7.5±0.8	0.6
	CS65-B2GA151KAVKA	В	150	± 10	7.0	7.0	7.5±0.8	0.6
	CS65-B2GA221KAVKA	В	220	± 10	7.0	7.0	7.5±0.8	0.6
	CS70-B2GA331KAVKA	В	330	± 10	7.5	7.0	7.5±0.8	0.6
	CS75-B2GA471KAVKA	В	470	± 10	9.0	7.0	7.5±0.8	0.6
	CS85-B2GA681KAVKA	В	680	± 20	9.5	7.0	7.5±0.8	0.6
	CS65ZU2GA102MAVKA	Z5U	1000	± 20	7.0	7.0	7.5±0.8	0.6
	CS75ZU2GA152MAVKA	Z5U	1500	± 20	8.0	7.0	7.5±0.8	0.6
	CS80ZU2GA222MAVKA	Z5U	2200	± 20	9.5	7.0	7.5±0.8	0.6
	CS95ZU2GA332MAVKA	Z5U	3300	± 20	12.0	7.0	7.5±0.8	0.6
	CS11ZU2GA472MAVKA	Z5U	4700	± 20	13.5	7.0	7.5±0.8	0.6



Flow soldering recommended condition



Fig-1

